

# P-Channel 100 V (D-S) MOSFET

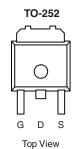
PRODUCT	SUMMARY		
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (Ω)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)
- 100	0.250 at $V_{GS}$ = - 10 V	- 8.8	11.7
- 100	0.280 at V <sub>GS</sub> = - 4.5 V	- 8.0	11.7

#### **FEATURES**

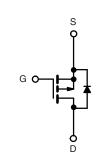
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET ٠
- 100 % R<sub>g</sub> and UIS Tested
  Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Power Switch
- DC/DC Converters •



Drain Connected to Tab



P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATING</b>	<b>S</b> T <sub>C</sub> = 25 °C, unless othe	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 100	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 25 °C	– I <sub>D</sub>	- 8.8	А	
	T <sub>C</sub> = 70 °C	D	- 7.1		
Pulsed Drain Current		I <sub>DM</sub>	- 25	A	
Avalanche Current		I <sub>AS</sub>	- 18		
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	16.2	mJ	
	T <sub>C</sub> = 25 °C	Р	32.1 <sup>b</sup>	w	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	– P <sub>D</sub>	2.5		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	50	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	3.9	0/11

Notes:

a. Duty cycle  $\leq$  1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).







Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 V, I_{D} = -250 \mu A$	- 100			v
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1		- 2.5	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 250	nA
		$V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μΑ
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	
		$V_{DS}$ = - 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 150 °C			- 250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 15			А
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3.6 A		0.250		Ω
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.4 A		0.280		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$		12		S
Dynamic <sup>b</sup>		· · · · ·				
Input Capacitance	C <sub>iss</sub>			1055		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = - 50 V, f = 1 MHz		65		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			41		
Total Gate Charge <sup>c</sup>	Qg	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.6 \text{ A}$		23.2	34.8	nC
Iotal Gate Charge				11.7	17.6	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = - 50 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 3.6 A		3.5		
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			4.8		
Gate Resistance	Rg	f = 1 MHz	1.2	5.7	11.5	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			7	14	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 50 V, $R_L$ = 17.2 $\Omega$		12	18	20
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$\rm I_D \cong$ - 2.9 A, $\rm V_{GEN}$ = - 10 V, $\rm R_g$ = 1 $\Omega$		33	50	ns
Fall Time <sup>c</sup>	t <sub>f</sub>			9	18	
Drain-Source Body Diode Ratings and	nd Character	istics T <sub>C</sub> = 25 °C <sup>b</sup>				
Continuous Current	۱ <sub>S</sub>				- 8.8	^
Pulsed Current	I <sub>SM</sub>				- 15	A
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 2.9 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.5	V
Reverse Recovery Time	t <sub>rr</sub>			50	75	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = - 2.9 A, dl/dt = 100 A/μs		- 4	- 6	Α
Reverse Recovery Charge	Q <sub>rr</sub>	1 1		98	147	nC

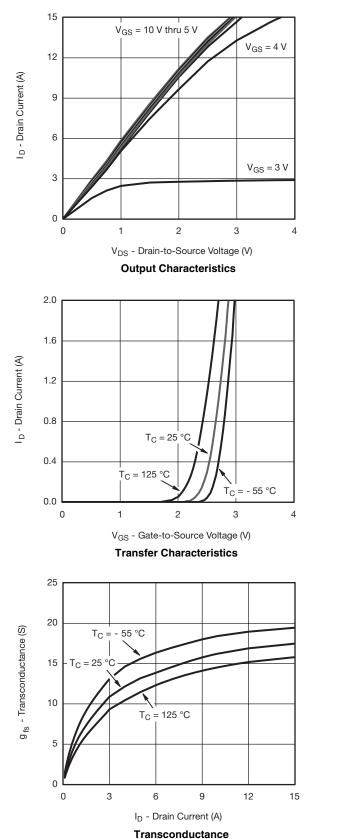
Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

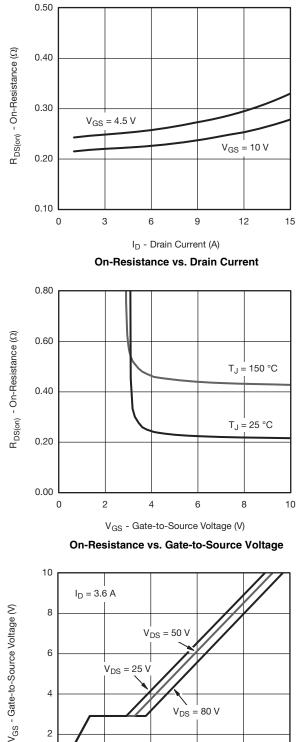
b. Guaranteed by design, not subject to production testing.c. Independent of operating temperature.

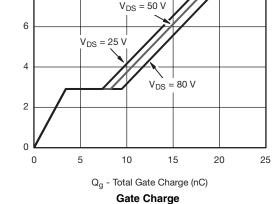
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





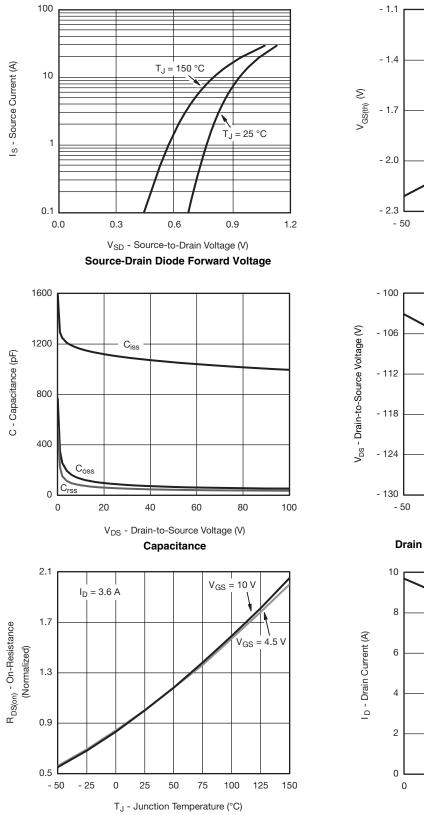
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



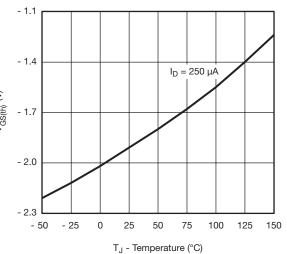




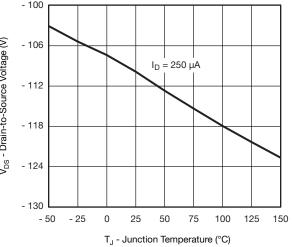
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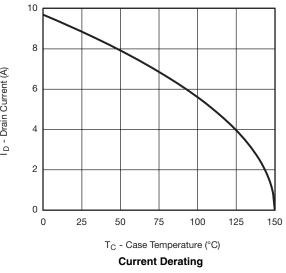
**On-Resistance vs. Junction Temperature** 



**Threshold Voltage** 



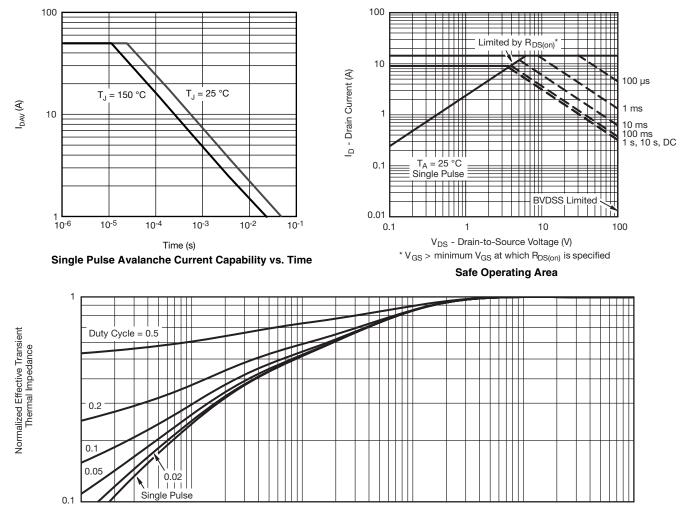
Drain Source Breakdown vs. Junction Temperature





### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

10<sup>-3</sup>



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

10-1

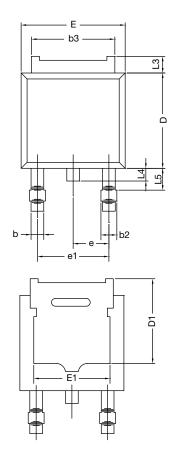
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10<sup>-2</sup>

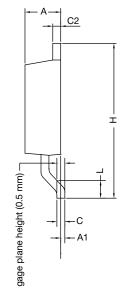
10-4

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## **TO-252AA Case Outline**



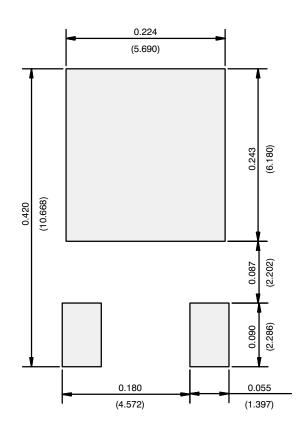
MIN.           2.18           -           0.64           0.76           4.95           0.46           5.97           4.10	MAX.           2.38           0.127           0.88           1.14           5.46           0.61           0.89           6.22	MIN.           0.086           -           0.025           0.030           0.195           0.018           0.018           0.235	MAX. 0.094 0.005 0.035 0.045 0.215 0.024 0.035
- 0.64 0.76 4.95 0.46 0.46 5.97	0.127 0.88 1.14 5.46 0.61 0.89	- 0.025 0.030 0.195 0.018 0.018	0.005 0.035 0.045 0.215 0.024 0.035
0.76 4.95 0.46 0.46 5.97	0.88 1.14 5.46 0.61 0.89	0.025 0.030 0.195 0.018 0.018	0.035 0.045 0.215 0.024 0.035
0.76 4.95 0.46 0.46 5.97	1.14 5.46 0.61 0.89	0.030 0.195 0.018 0.018	0.045 0.215 0.024 0.035
4.95 0.46 0.46 5.97	5.46 0.61 0.89	0.195 0.018 0.018	0.215 0.024 0.035
0.46 0.46 5.97	0.61 0.89	0.018 0.018	0.024
0.46 5.97	0.89	0.018	0.035
5.97			
	6.22	0.235	0.045
4.10			0.245
	-	0.161	-
6.35	6.73	0.250	0.265
4.32	-	0.170	-
9.40	10.41	0.370	0.410
2.28	BSC	0.090	) BSC
4.56 BSC		0.180 BSC	
1.40	1.78	0.055	0.070
0.89	1.27	0.035	0.050
-	1.02	-	0.040
1.01	1.52	0.040	0.060
	4.56 1.40 0.89 - 1.01	1.40         1.78           0.89         1.27           -         1.02           1.01         1.52	4.56 BSC         0.180           1.40         1.78         0.055           0.89         1.27         0.035           -         1.02         -

#### Notes

• Dimension L3 is for reference only.



### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)



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